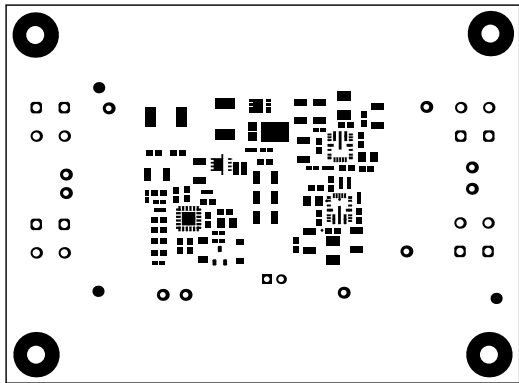
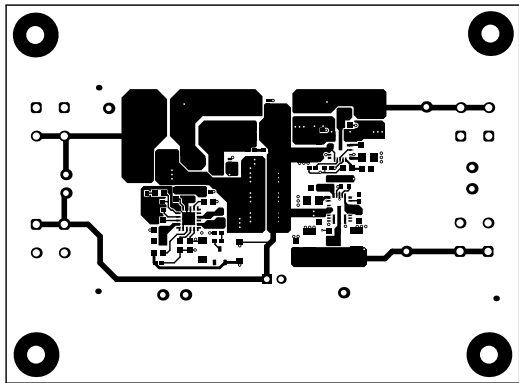


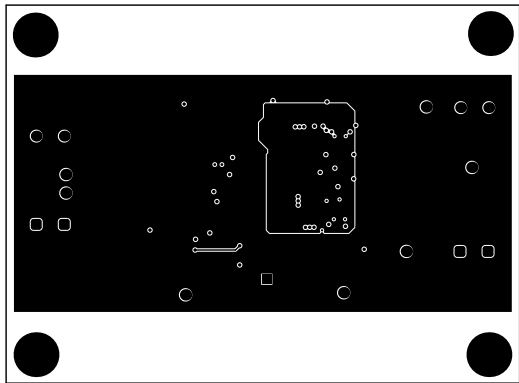
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 1/14/2019	10:17:17 AM	TEXAS INSTRUMENTS



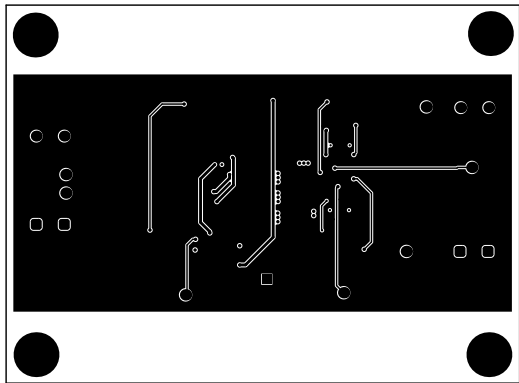
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 1/14/2019 10:17:18 AM	TEXAS INSTRUMENTS	



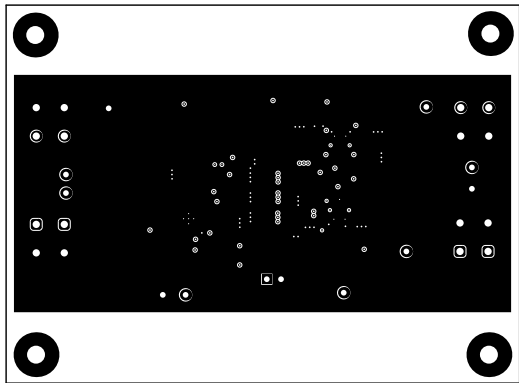
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 1/14/2019 10:17:19 AM	TEXAS INSTRUMENTS	



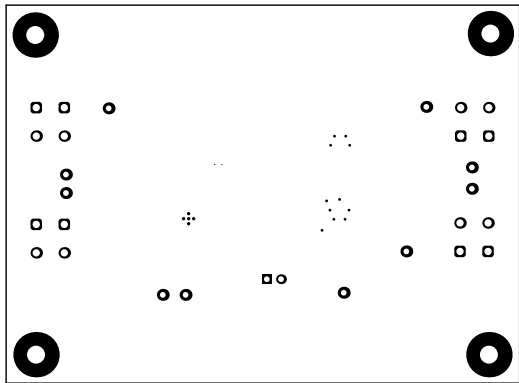
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A		
PLOT NAME = Signal 1	GENERATED : 1/14/2019 10:17:20 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A		
PLOT NAME = Signal 2	GENERATED : 1/14/2019 10:17:21 AM	TEXAS INSTRUMENTS	



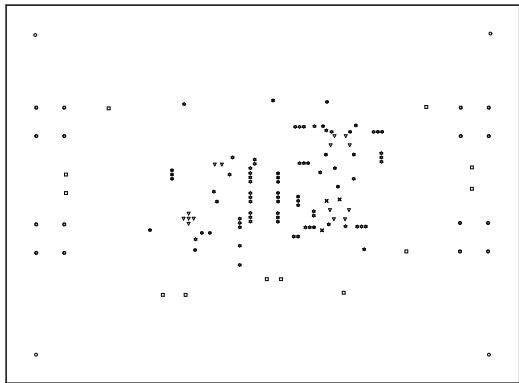
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 1/14/2019 10:17:22 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 1/14/2019 10:17:23 AM	TEXAS INSTRUMENTS	



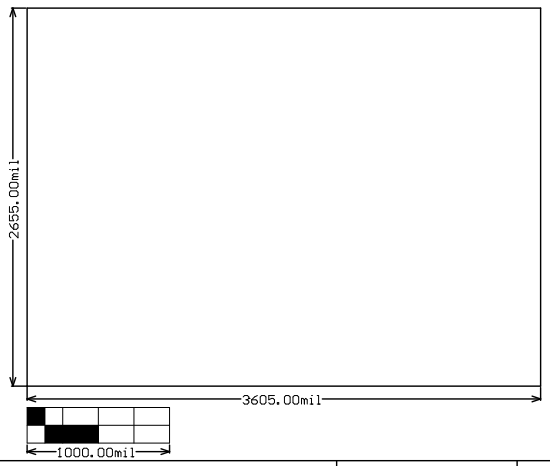
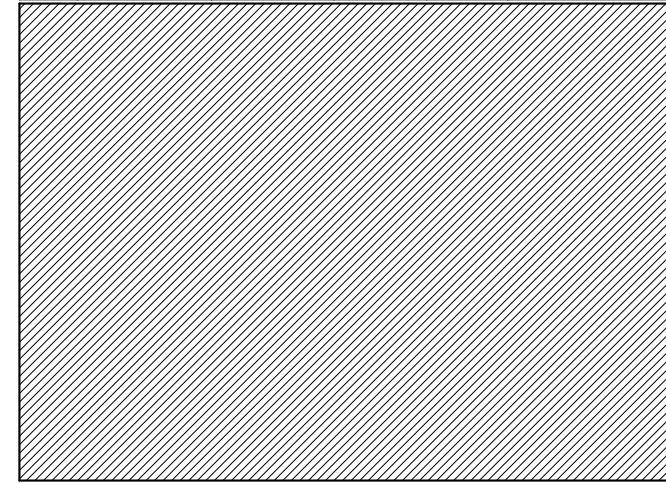
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 1/14/2019 10:17:24 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
▽	15	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
✕	3	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	81	11.94mil (0.303mm)	PTH	Round	Top Layer - Bottom Layer	
□	12	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
⊙	16	51.18mil (1.300mm)	PTH	Round	Top Layer - Bottom Layer	±0.34mil
○	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
131 Total						

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 1/14/2019	10:17:25 AM	TEXAS INSTRUMENTS

Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	0.40mil	3.5	
3	Top Layer	Copper	1.40mil		
4	Dielectric 1	FR-4	8.00mil	4.2	
5	Signal Layer 1	Copper	1.40mil		
6	Dielectric 2	FR-4	40.00mil	4.2	
7	Signal Layer 2	Copper	1.40mil		
8	Dielectric 3	FR-4	8.00mil	4.2	
9	Bottom Layer	Copper	1.40mil		
10	Bottom Solder	Solder Resist	0.40mil	3.5	
11	Bottom Overlay				



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30548	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 1/14/2019 10:17:26 AM	TEXAS INSTRUMENTS	

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